LM18293 Four Channel Push-Pull Driver

## LM18293

## Four Channel Push-Pull Driver

## **General Description**

The LM18293 is designed to drive DC loads up to one amp. Typical applications include driving such inductive loads as solenoids, relays and stepper motors along with driving switching power transistors and use as a buffer for low level logic signals. The four inputs accept standard TTL and DTL levels for ease of interfacing. Two enable pins are provided that also accept the standard TTL and DTL levels. Each enable controls 2 channels and when an enable pin is disabled (tied low), the corresponding outputs are forced to the TRI-STATE® condition. If the enable pins are not connected (i.e., floating), the circuit will function as if it has been enabled. Separate pins are provided for the main power supply (pin 8), and the logic supply (pin 16). This allows a lower voltage to be used to bias up the logic resulting in reduced power dissipation. The chip is packaged in a specially de-

signed 16 pin power DIP. The 4 center pins of this package are tied together and form the die paddle inside the package. This provides much better heat sinking capability than most other DIP packages available. The device is capable of operating at voltages up to 36 volts.

### **Features**

- 1A output current capability per channel
- Pin for pin replacement for L293B
- Special 16 pin power DIP package
- 36 volt operation
- Internal thermal overload protection
- Logical "0" input voltage up to 1.5 volts results in high noise immunity

### **Typical Connection**

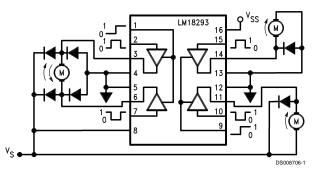


FIGURE 1. Application circuit showing bidirectional and on/off control of a single DC motor using two outputs and unidirectional on/off function of two DC motors using a single output each.

Order Number LM18293N

NS Package Number N16A

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<b>Absolute Maximum Ratings</b>	(Note 1)	Junction Temperature (T <sub>J</sub> )	+150°C	
If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.		Thermal Resistance Junction to Case $(\theta_{JC})$ Thermal Resistance Junction	14°C/W	
Output Drive Supply Voltage (V <sub>S</sub> ) Logic Supply Voltage (V <sub>SS</sub> )	36V 36V	to Ambient ( $\theta_{JA}$ ) Internal Power Dissipation	80°C/W Internally Limited	
Input Voltage (V <sub>I</sub> )	7V	Operating Temperature Range	-40°C to +125°C -65°C to +150°C	
Enable Voltage (V <sub>E</sub> ) Peak Output Current	7V	Storage Temperature Range Lead Temperature	-65 C t0 +150 C	
(Non-Repetitive t = 5 ms)	2A	(Solder 10 seconds)	260°C	

### **Electrical Characteristics**

 $V_S$  = 24V,  $V_{SS}$  = 5V, T = 25°C, L = 0.4V, H = 3.5V, each channel, unless otherwise noted

Symbol	Parameter	Conditions	Typical	Tested Limit (Note 2)	Design Limit (Note 3)	Units
V <sub>s</sub>	Main Supply (Pin 8)	Maximum Supply Voltage		36		Vmax
V <sub>SS</sub>	Logic Supply (Pin 16)	Minimum Logic Supply Voltage		4.5		Vmin
		Maximum Logic Supply Voltage		36		Vmax
Is	Total Quiescent	$V_I = L$ $I_O = 0$ $V_E = H$	2	6		mAmax
	Supply Current	$V_I = H$ $I_O = 0$ $V_E = H$	16	24		mAmax
		V <sub>E</sub> = L		4		mAmax
I <sub>ss</sub>	Total Quiescent Logic	$V_I = L$ $I_O = 0$ $V_E = H$	44	60		mAmax
	Supply Current	$V_I = H$ $I_O = 0$ $V_E = H$	16	22		mAmax
	(pin 16)	V <sub>E</sub> = L	16	24		mAmax
V <sub>I</sub>	Input Voltage	Min Value of Low		-0.3		Vmin
		Max Value of Low		1.5		Vmax
		Min Value of High		2.3		Vmin
		Max Value of High (V <sub>SS</sub> ≤ 7)		V <sub>ss</sub>		Vmax
		Max Value of High (V <sub>SS</sub> > 7)		7		Vmax
I <sub>I</sub>	Input Current	V <sub>I</sub> = L		-10		μAmax
		V <sub>I</sub> = H	30	100		μAmax
V <sub>E</sub>	Enable Voltage	Min Value of Low		-0.3		Vmin
	(Pins 1, 9)	Max Value of Low		1.5		Vmax
		Min Value of High		2.3		Vmin
		Max Value of High (V <sub>SS</sub> ≤7)		V <sub>SS</sub>		Vmax
		Max Value of High (V <sub>SS</sub> >7)		7		Vmax
I <sub>E</sub>	Enable Current	V <sub>E</sub> = L	-30	-100		μAmax
		V <sub>E</sub> = H		±10		μAmax
V <sub>CE</sub> sat Top	Source Saturation Voltage	I <sub>o</sub> = -1 amp	1.4	1.8		Vmax
V <sub>CE</sub> sat Bottom	Sink Saturation Voltage	I <sub>o</sub> = 1 amp	1.2	1.8		Vmax
t <sub>r</sub>	Rise Time	10%–90% V <sub>o</sub>	250			ns
t <sub>f</sub>	Fall Time	90%–10% V <sub>o</sub>	250			ns
t <sub>on</sub>	Turn-On Delay	50% V <sub>I</sub> to 50% V <sub>o</sub>	450			ns
t <sub>off</sub>	Turn-Off Delay	50% V <sub>1</sub> to 50% V <sub>2</sub>	200			ns

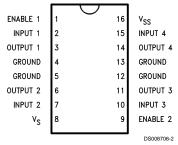
Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Electrical specifications do not apply when operating the device beyond its rated operating conditions.

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 $<sup>\</sup>textbf{Note 2:} \ \, \textbf{Tested limits are guaranteed and 100\% production tested}.$ 

Note 3: Design limits are guaranteed (but not 100% production tested) over the full supply and temperature range. These limits are not used to calculate outgoing quality levels.

# **Connection Diagram**

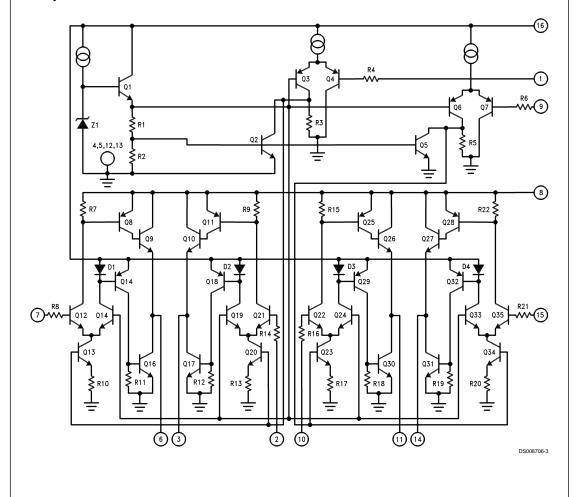


Enable 1 activates outputs 1 & 2 Enable 2 activates outputs 3 & 4

**TABLE 1. Input/Output Truth Table** 

V <sub>E</sub> (**)	V <sub>I</sub> (Each Channel)	٧o
Н	Н	Н
Н	L	L
L	Н	X (*)
L	L	X (*)

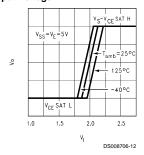
## **Simplified Schematic**



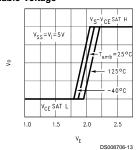
<sup>(\*)</sup> High output impedance.
(\*\*) Relative to the pertinent channel.

# **Typical Performance Characteristics**

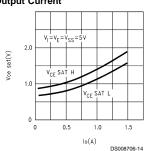
### Output Voltage vs. Input Voltage



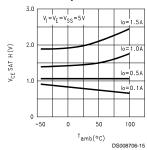
### Output Voltage vs. Enable Voltage



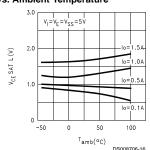
#### Saturation Voltage vs. Output Current



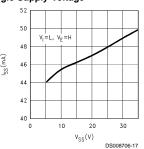
# Source Saturation Voltage vs. Ambient Temperature



# Sink Saturation Voltage vs. Ambient Temperature



#### Quiescent Logic Supply Current vs. Logic Supply Voltage



# **Typical Applications**

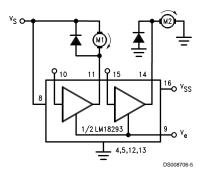


FIGURE 2. DC motor controls (with connections to ground and to the supply voltages)



VE	Pin	Pin	M1	M2
	10	15		
Н	Н	Н	Fast Motor Stop	Run
Н	Н	L	Fast Motor Stop	Fast Motor Stop
Н	L	Н	Run	Run
Н	L	L	Run	Fast Motor Stop
L	Х	Х	Free Running	Free Running
			Motor Stop	Motor Stop

L = Low H = High X = Don't care

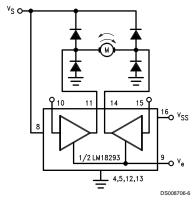


FIGURE 3. Bidirectional DC motor control

**TABLE 3. Bidirectional DC Motor Control** 

Inputs		Function
Pin 10 = H		Turn CW
Pin 15 = L		
V <sub>E</sub> = H	Pin 10 = L	Turn CCW
	Pin 15 = H	
	Pin 10 = Pin 15	Fast Motor Stop
V <sub>E</sub> = L	Pin 10 = X	Free Running
	Pin 15 = X	Motor Stop

## Bipolar Stepping Motor Control (see Figure 4)

TABLE 4. Full Step Sequencing (Note 4)

V <sub>IN</sub> 1	V <sub>IN</sub> 2	Step
L	L	1
L	Н	2
Н	Н	3
Н	L	4
L	L	1

Note 4:  $V_E$  1 and  $V_E$  2 = H

TABLE 5. Half Step Sequencing

V <sub>E</sub> 1	V <sub>E</sub> 2	V <sub>IN</sub> 1	V <sub>IN</sub> 2	Step
Н	L	L	Х	1
Н	Н	L	L	2
L	Н	Х	L	3
Н	Н	Н	L	4
Н	L	Н	Х	5
Н	Н	Н	Н	6
L	Н	Х	Н	7
Н	Н	L	Н	8
Н	L	L	Х	1

L = Low H = High X = Don't care

H = High L = Low

X = Don't care

## **Bipolar Stepping Motor Control**

(see Figure 4) (Continued)

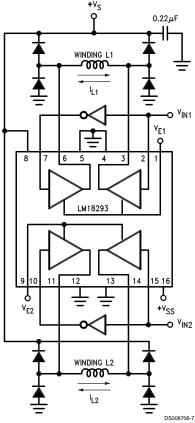


FIGURE 4. Motor Control Block Diagram

### **Mounting Instructions**

The junction to ambient thermal resistance of the LM18293 can be reduced by soldering the ground pins to a suitable copper area of the printed circuit board or to an external heatsink. The graph of  $Figure\ 7$  which shows the maximum power dissipated and junction to ambient thermal resistance as a function of the side "L" of two equal square copper areas having a thickness of  $35\mu$ , as in  $Figure\ 6$ , illustrates this. In addition, it is possible to use an external heatsink (see  $Figure\ 5$ ). During soldering the pins temperature must not exceed  $230^\circ\text{C}$  and the soldering time must not be longer than 12 seconds. The external heatsink or printed circuit copper area must be connected to electrical ground.

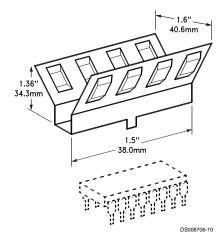


FIGURE 5. Staver External Heat-sink

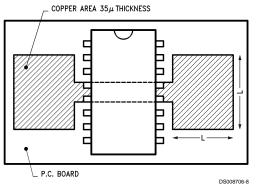


FIGURE 6. PCB Thermal Layout

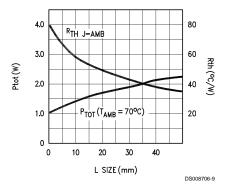


FIGURE 7. Maximum Power Dissipated and Junction to Ambient Thermal Resistance vs. Size

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# Mounting Instructions (Continued)

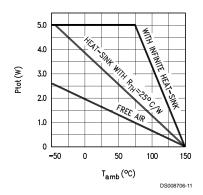
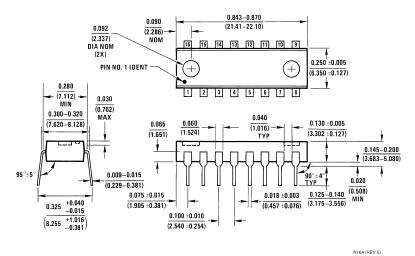


FIGURE 8. Maximum Allowable Power Dissipation vs Ambient Temperature

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### Physical Dimensions inches (millimeters) unless otherwise noted



Molded Dual-In-Line Package (N) Order Number LM18293N NS Package Number N16A

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